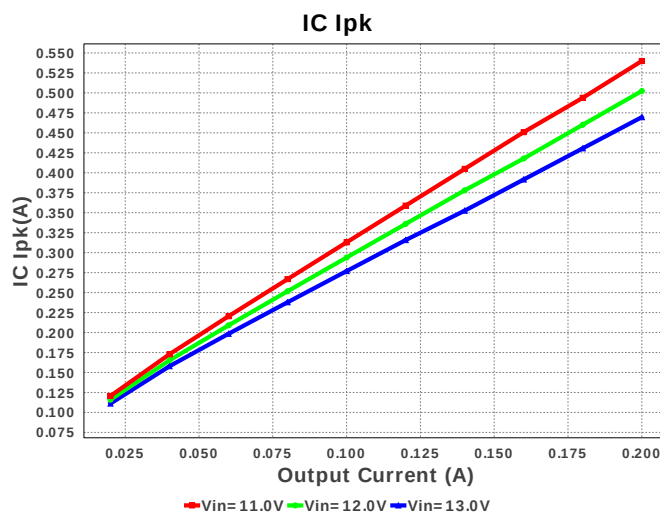
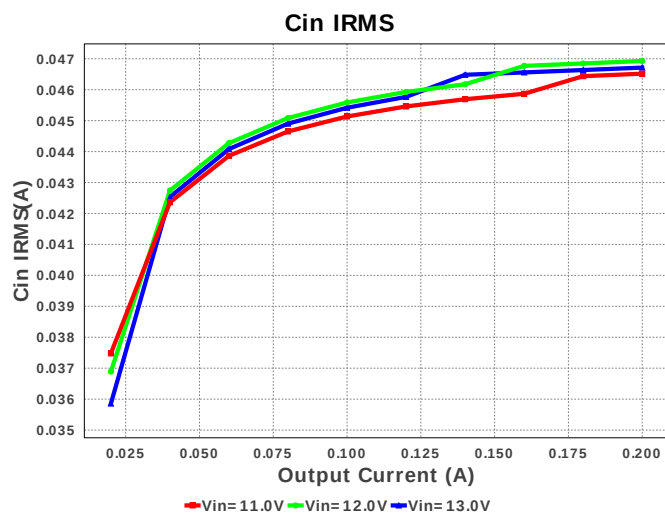
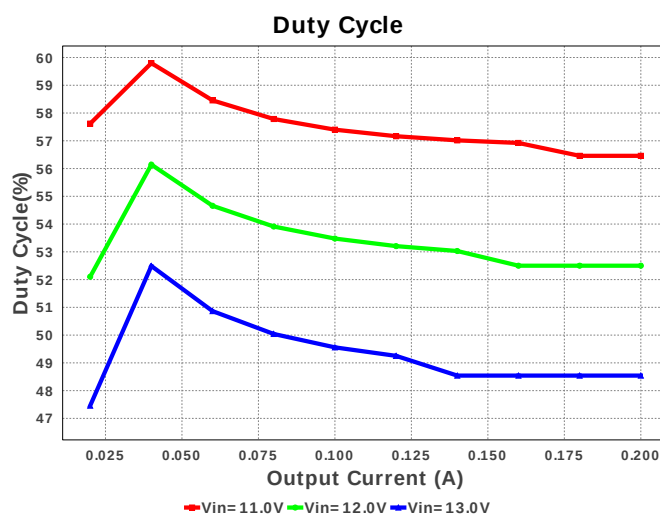
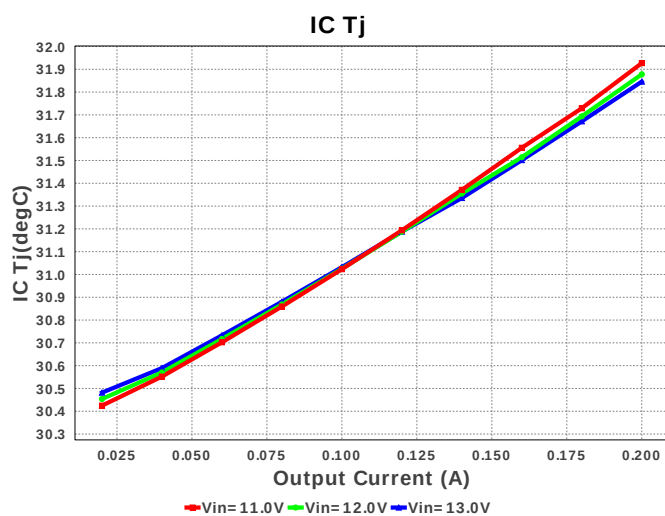
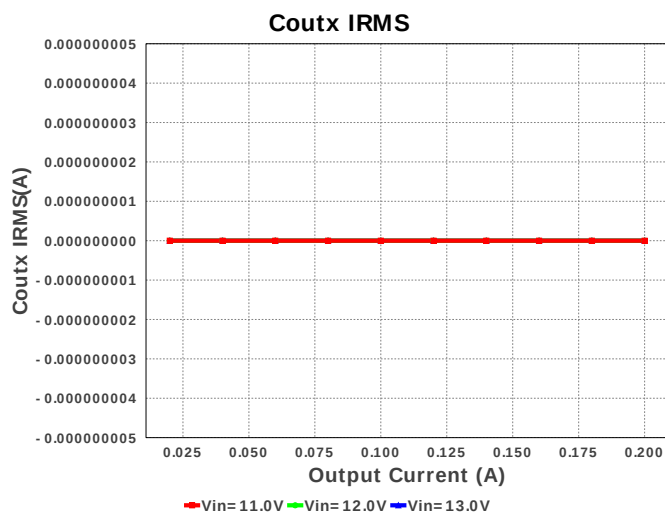
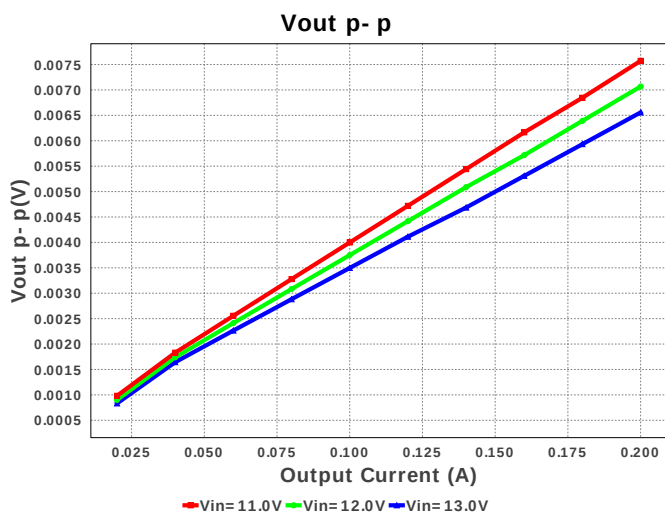
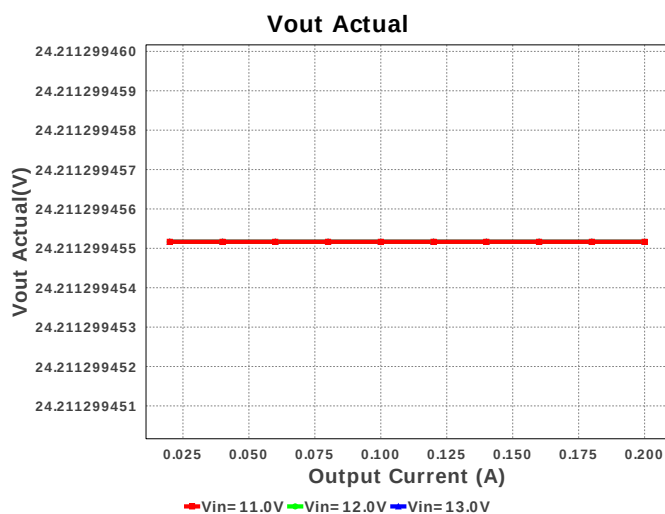
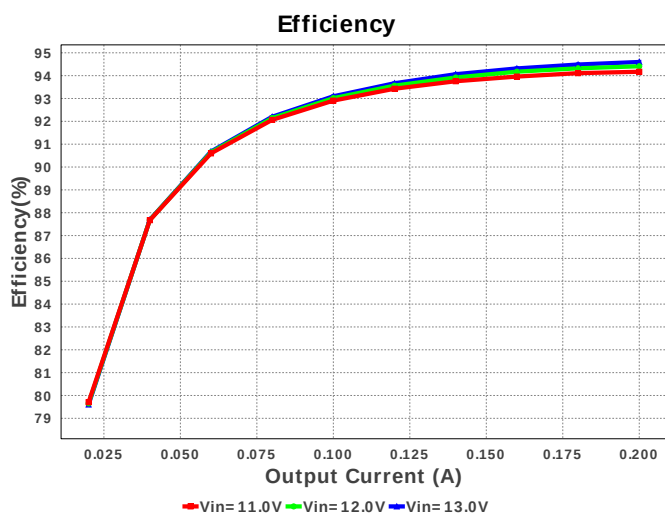
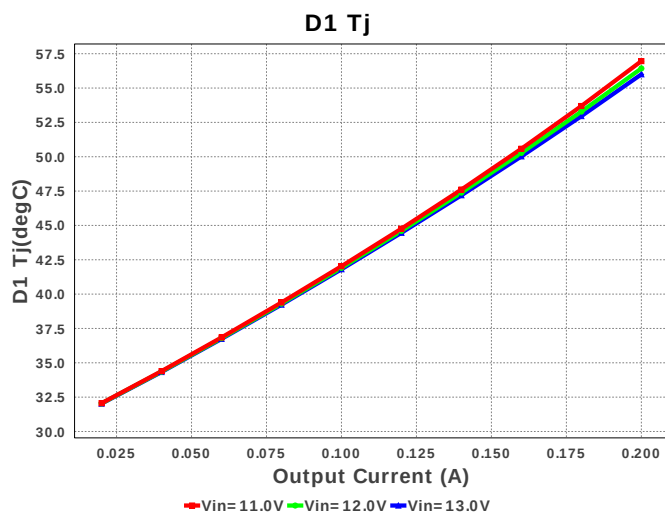
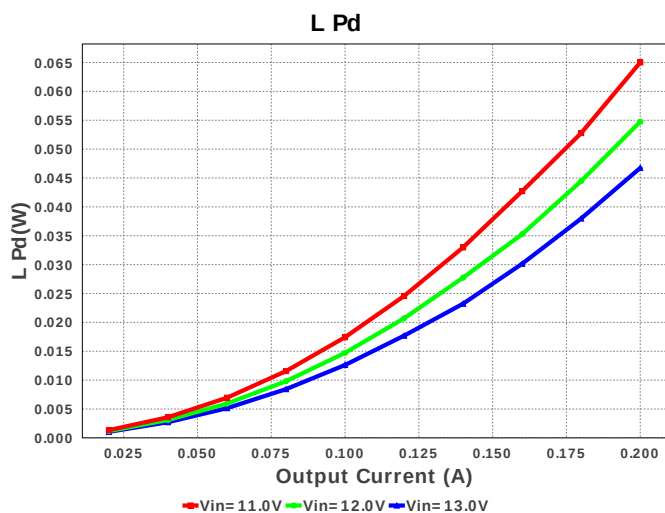


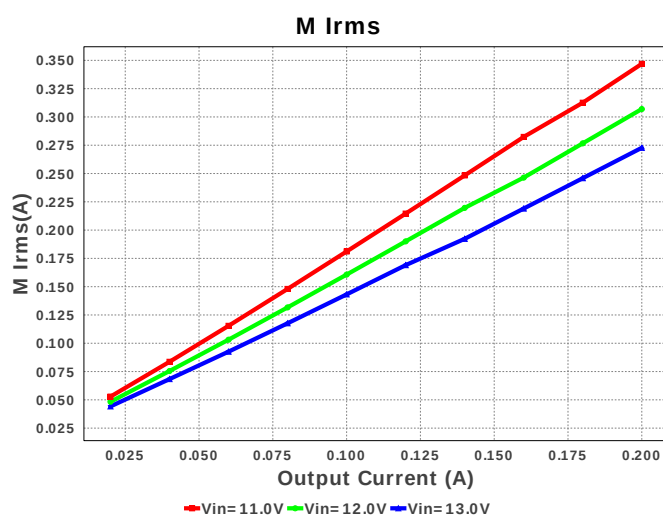
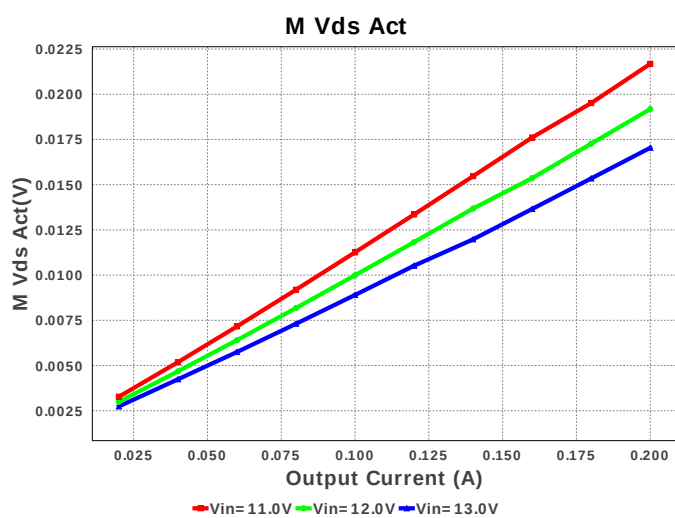
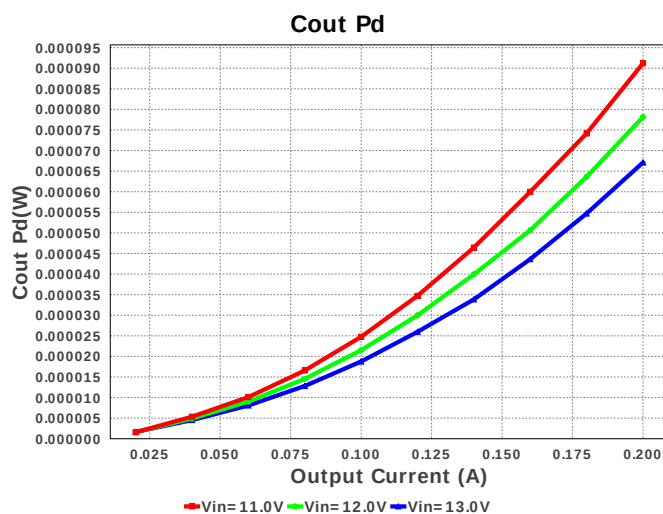
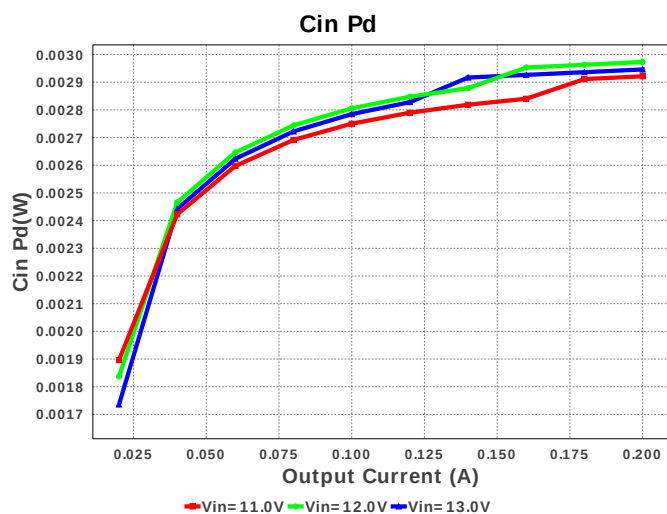
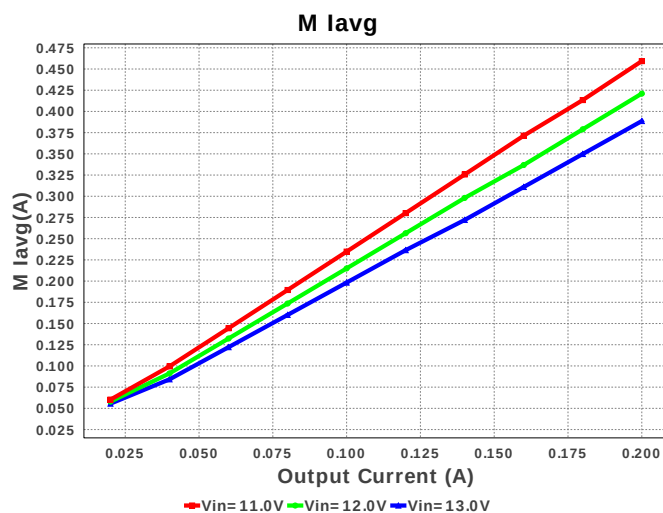
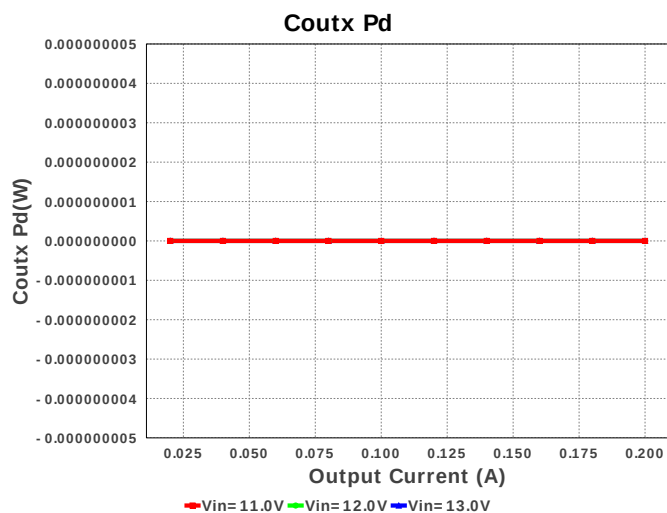


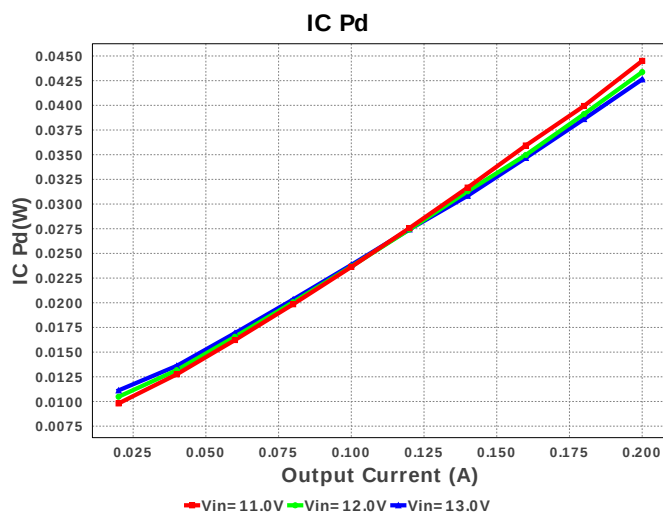
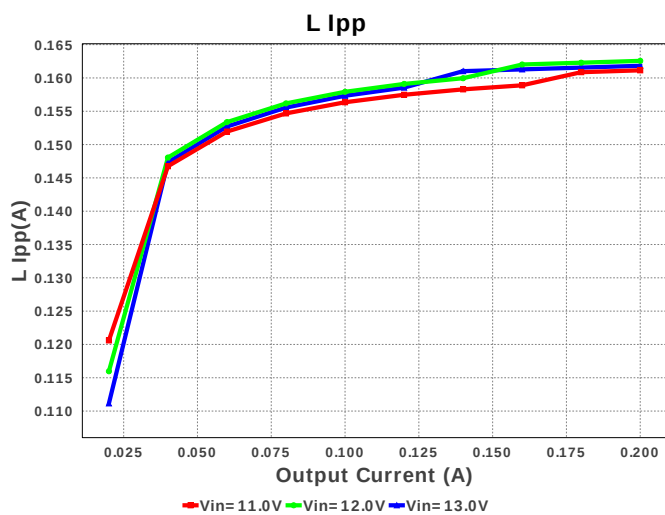
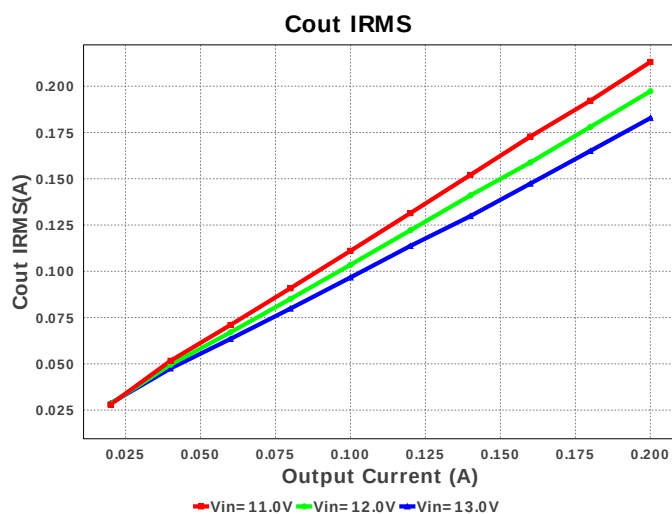
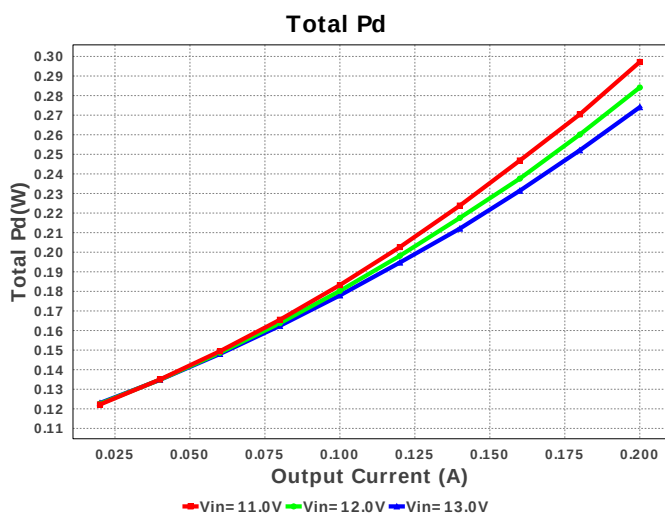
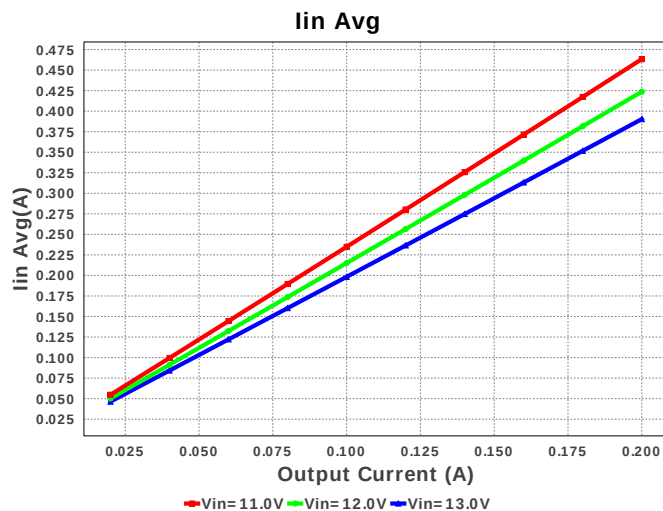
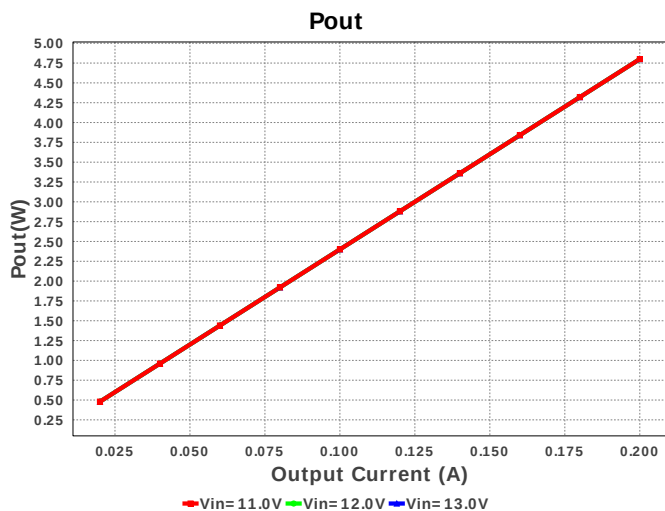
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Topology = Boost
Created = 7/15/16 8:34:10 PM
BOM Cost = \$4.06
BOM Count = 14
Total Pd = 0.3W

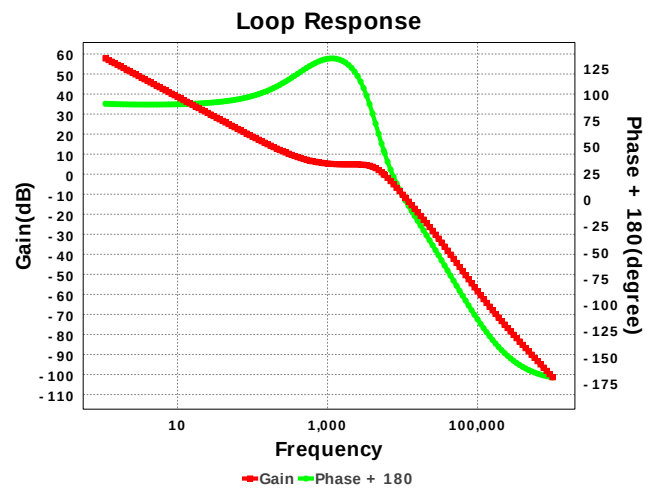
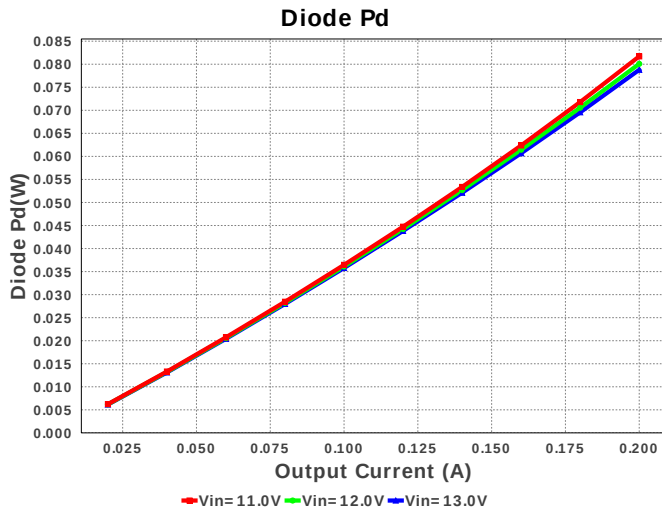
#	Name	Manufacturer	Part Number	Properties	Qty	Price	Footprint
13.	Rt	Vishay-Dale	CRCW040260K4FKED Series= CRCW..e3	Res= 60.4 kOhm Power= 63.0 mW Tolerance= 1.0%	1	\$0.01	0402 3 mm ²
14.	U1	Texas Instruments	TPS55340RTER	Switcher	1	\$1.85	S-PWQFN-N16 17 mm ²











Operating Values

#	Name	Value	Category	Description
1.	Cin IRMS	46.518 mA	Current	Input capacitor RMS ripple current
2.	Cout IRMS	213.106 mA	Current	Output capacitor RMS ripple current
3.	Coutx IRMS	0.0 A	Current	Output capacitor_x RMS ripple current
4.	IC Ipk	539.902 mA	Current	Peak switch current in IC
5.	Iin Avg	463.38 mA	Current	Average input current
6.	L Ipp	161.14 mA	Current	Peak-to-peak inductor ripple current
7.	M Iavg	459.33 mA	Current	MOSFET Average current
8.	M1 Irms	346.9 mA	Current	Q Iavg
9.	BOM Count	14	General	Total Design BOM count
10.	FootPrint	163.0 mm ²	General	Total Foot Print Area of BOM components
11.	Frequency	778.91 kHz	General	Switching frequency
12.	IC Tolerance	9.0 mV	General	IC Feedback Tolerance
13.	M Vds Act	21.679 mV	General	Voltage drop across the MosFET
14.	Pout	4.8 W	General	Total output power
15.	Total BOM	\$4.06	General	Total BOM Cost
16.	D1 Tj	56.962 degC	Op_Point	D1 junction temperature
17.	Low Freq Gain	58.226 dB	Op_Point	Gain at 10Hz
18.	Vout Actual	24.211 V	Op_Point	Vout Actual calculated based on selected voltage divider resistors
19.	Vout OP	24.0 V	Op_Point	Operational Output Voltage
20.	Cross Freq	4.023 kHz	Op_point	Bode plot crossover frequency
21.	Duty Cycle	56.458 %	Op_point	Duty cycle
22.	Efficiency	94.17 %	Op_point	Steady state efficiency
23.	Gain Marg	-14.128 dB	Op_point	Bode Plot Gain Margin
24.	IC Tj	31.927 degC	Op_point	IC junction temperature
25.	ICThetaJA	43.3 degC/W	Op_point	IC junction-to-ambient thermal resistance
26.	IOUT_OP	200.0 mA	Op_point	Iout operating point
27.	Phase Marg	56.322 deg	Op_point	Bode Plot Phase Margin
28.	VIN_OP	11.0 V	Op_point	Vin operating point
29.	Vout p-p	7.572 mV	Op_point	Peak-to-peak output ripple voltage
30.	Cin Pd	2.921 mW	Power	Input capacitor power dissipation
31.	Cout Pd	91.191 μ W	Power	Output capacitor power dissipation
32.	Coutx Pd	0.0 W	Power	Output capacitor_x power loss
33.	Diode Pd	81.702 mW	Power	Diode power dissipation
34.	IC Pd	44.505 mW	Power	IC power dissipation
35.	L Pd	65.01 mW	Power	Inductor power dissipation
36.	Total Pd	297.166 mW	Power	Total Power Dissipation
37.	Vout Tolerance	2.664 %		Vout Tolerance based on IC Tolerance (no load) and voltage divider resistors if applicable

Design Inputs

#	Name	Value	Description
1.	Iout	200.0 m	Maximum Output Current
2.	VinMax	13.0	Maximum input voltage
3.	VinMin	11.0	Minimum input voltage
4.	Vout	24.0	Output Voltage
5.	base_pn	TPS55340	Base Product Number
6.	source	DC	Input Source Type
7.	Ta	30.0	Ambient temperature

Design Assistance

1. **TPS55340** Product Folder : <http://www.ti.com/product/TPS55340> : contains the data sheet and other resources.

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